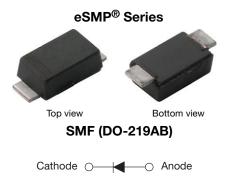
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# Ultrafast Rectifier, 1 A FRED Pt<sup>®</sup>



DESIGN SUPPORT TOOLS [click logo to get started.



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	1 A			
V <sub>R</sub>	600 V			
V <sub>F</sub> at I <sub>F</sub>	0.83 V			
t <sub>rr</sub>	55 ns			
T <sub>J</sub> max.	175 °C			
Package	SMF (DO-219AB)			
Circuit configuration	Single			

#### FEATURES

- Ultrafast recovery time, reduced  $\mathsf{Q}_{\mathsf{rr}},$  and soft recovery
- 175 °C maximum operating junction temperature
- For PCF CRM, snubber operation
- Low forward voltage drop
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **DESCRIPTION / APPLICATIONS**

State of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop, ultrafast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in PFC, boost, lighting, in the AC/DC section of SMPS, freewheeling and clamp diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Peak repetitive reverse voltage	V <sub>RRM</sub>		600	V			
Average rectified forward current	I <sub>F(AV)</sub>	$T_{\rm C} = 158 \ ^{\circ}{\rm C}^{(1)}$	1	٨			
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_J = 25 \text{ °C}, 6 \text{ ms}$ square pulse	30	A			
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C			

Note

<sup>(1)</sup> Device on PCB with 8 mm x 16 mm soldering lands

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN. TYP.		MAX.	UNITS	
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-	
Forward voltage		$I_F = 1 A$	-	1.0	1.2	V
Forward voltage V <sub>F</sub>	I <sub>F</sub> = 1 A, T <sub>J</sub> = 150 °C	-	0.83	1		
		V <sub>R</sub> = V <sub>R</sub> rated	-	-	3	
Reverse leakage current I <sub>R</sub>	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	20	100	μA	
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	5	-	pF

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 1
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ROHS COMPLIANT HALOGEN

FREE



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}$	õs, V <sub>R</sub> = 30 V	-	42	-	
Reverse recovery time	+	$I_{\rm F} = 0.5 \text{ A}, I_{\rm R} = 1 \text{ A}, I_{\rm rr}$	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A		-	55	
neverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	32	-	ns
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 1 A dI <sub>F</sub> /dt = 500 A/μs V <sub>B</sub> = 400 V	-	47	-	
Deals recover a current	1	T <sub>J</sub> = 25 °C		-	4.8	-	^
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		-	6.8	-	A
Reverse recovery charge Q <sub>rr</sub>	0	T <sub>J</sub> = 25 °C	1	-	77	-	nC
	Qrr	T <sub>J</sub> = 125 °C	]	-	160	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C
Thermal resistance, junction to case	R <sub>thJC</sub>	Device mounted on PCB with 8 mm x 16 mm soldering lands	-	-	15	°C/W
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Device mounted on PCB with 2 mm x 3.5 mm soldering lands	-	-	130	°C/W
Approximate weight				0.015		g
Approximate weight				0.0005		oz.
Marking device		Case style SMF (DO-219AB)		М	NU	

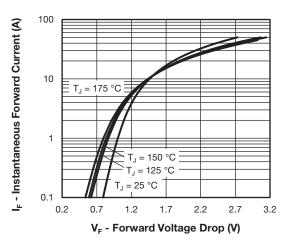


Fig. 1 - Typical Forward Voltage Drop Characteristics

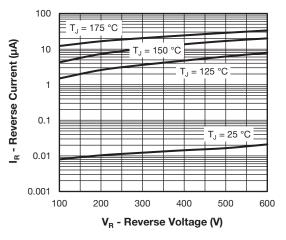


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage





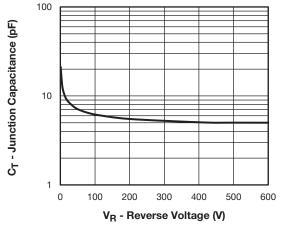


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

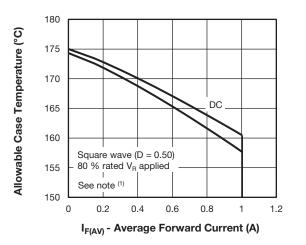


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

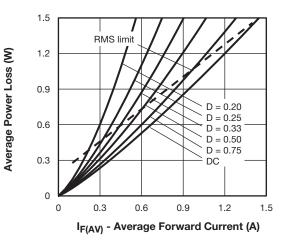


Fig. 5 - Forward Power Loss Characteristics

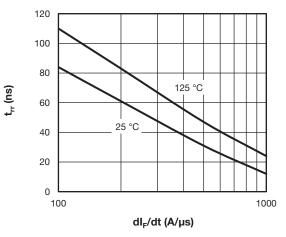


Fig. 6 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

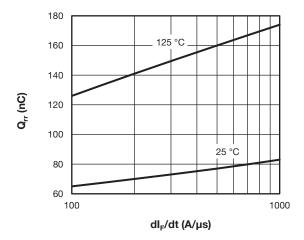


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;

 $\begin{array}{l} \mathsf{Pd} = \mathsf{forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ 5); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$ 

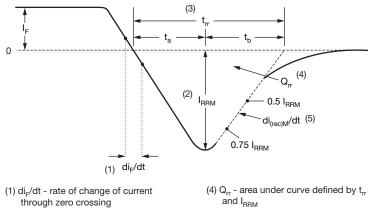
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## VS-1EFU06HM3

### **Vishay Semiconductors**



- (2)  ${\rm I}_{\rm RRM}$  peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.

 $Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$ 

(5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 

Fig. 8 - Reverse Recovery Waveform and Definitions

#### **ORDERING INFORMATION TABLE**

www.vishay.com

Device code	VS-	1	Е	F	U	06	н	М3
	1	2	3	4	5	6	7	8
			-	nicondu ing (1 =		oduct		
			cuit con single c	figuratio	n:			
	4		SMF pa					
	5		cess typ ultrafas	pe, st recove	ery			
			0	de (06 =	,			
	7			101 qua jen-free,		complia	ant, and	termin

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER REEL MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION					
VS-1EFU06HM3/I	10 000	10 000	13"diameter plastic tape and reel			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95572				
Part marking information	www.vishay.com/doc?95618				
Packaging information	www.vishay.com/doc?95577				
SPICE model	www.vishay.com/doc?95639				

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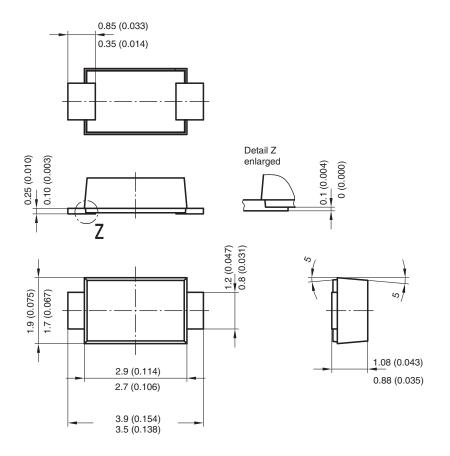
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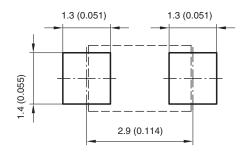


## SMF (DO-219AB)

#### **DIMENSIONS** in millimeters (inches)



Foot print recommendation:



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